



67,200-377; TSMC 00-723  
Serial Number 10/632,379

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**TO:** Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**FROM:** Tung & Associates  
838 West Long Lake Road - Suite 120  
Bloomfield Hills, MI 48302

**DATE:** 29 April 2004

**REF:** Appellant : Yang et al Filing Date : 1 August 2003  
Serial No. : 10/632,379 Att'y No. : 67,200-377; TSMC 00-723  
Art Unit : 2814 Examiner : Dana Farahani  
Title : Field Effect Transistor Device Having Corrugated Structure and  
Method for Fabrication Thereof

**AMENDMENT AND RESPONSE TO OFFICE ACTION**


Sir:

In response to an office action mailed on 27 March 2004, please consider the following amendments and remarks pertaining to the above referenced application.

There are no amendments to the specification. Amendments to the claims are found within a Listing of the Claims that begins on page 2 of this paper. There are no amendments to the drawings. Remarks begin on page 6 of this paper.

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, POB 1450, Alexandria, VA 22313-1450, on June 28, 2004.

  
Kathy Dixon

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